



Nonlinear injection kicker prototype for installation at the Australian Synchrotron

Beam Dynamics, Injection and Impedance Studies

Dr. Rebecca Auchetti, Dr. Rohan Dowd, Mr. Eugene Tan

Australian Synchrotron

rebecca@ansto.gov.au

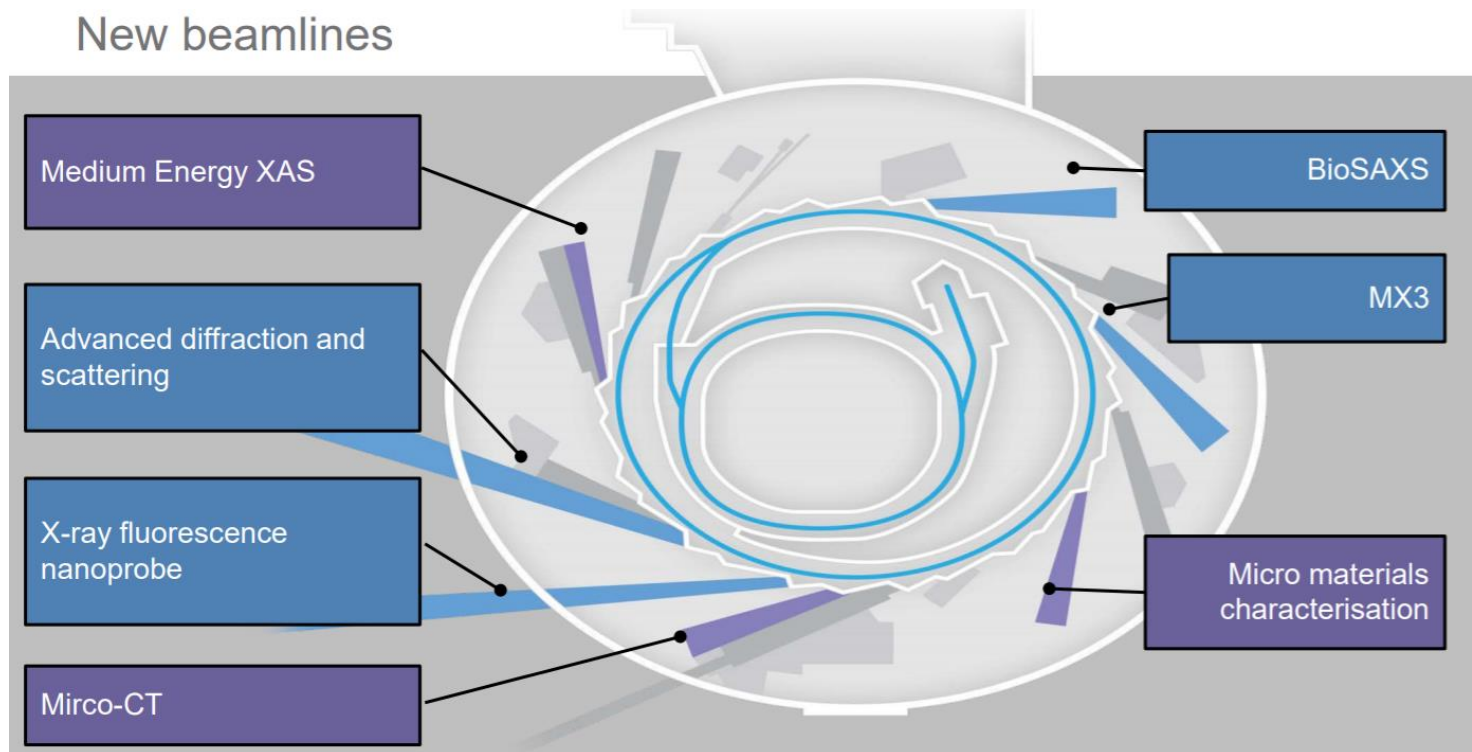
Science. Ingenuity. Sustainability.

The Australian Synchrotron Facility



BRIGHT program/Phase 2 development

- Bright beamlines
 - 7 new beamlines over the next 3-5 years

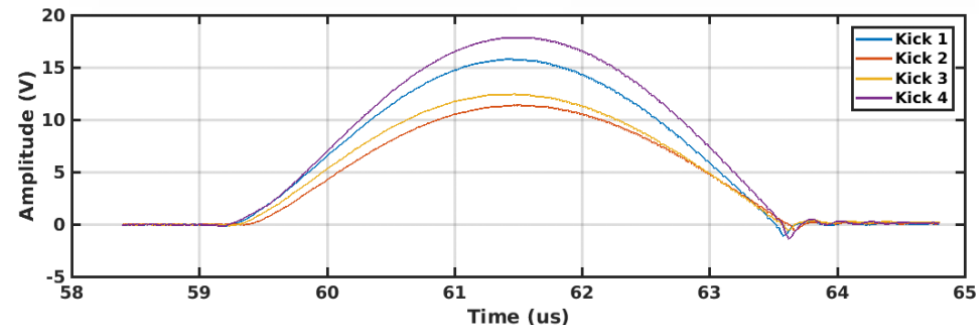
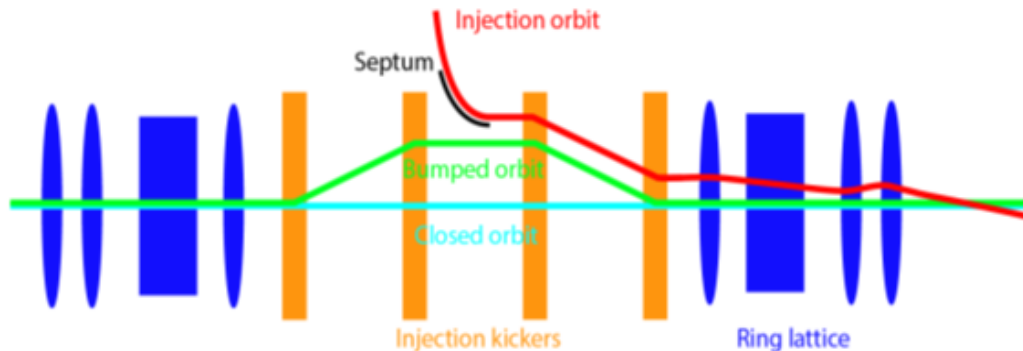
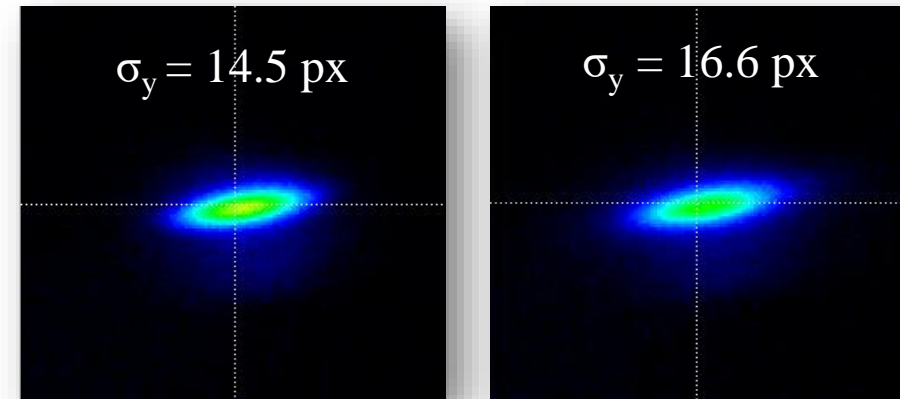


Future proofing

- Requirements for BRIGHT and next gen facility
 - Meet demands in medical and material
 - New beamlines to be installed
- The current configuration is insufficient for the future requirements/development

Insufficiencies in the current kicker configuration

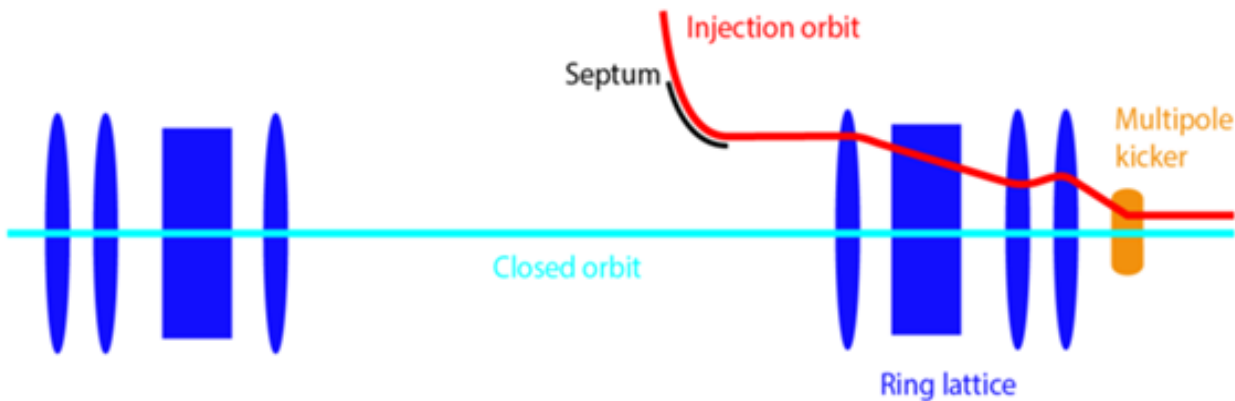
- Not compact
 - Takes up 4 meters of space where a IVU will be installed
- Not transparent during top up
 - Impact on Far-IR beamline
- Jitter



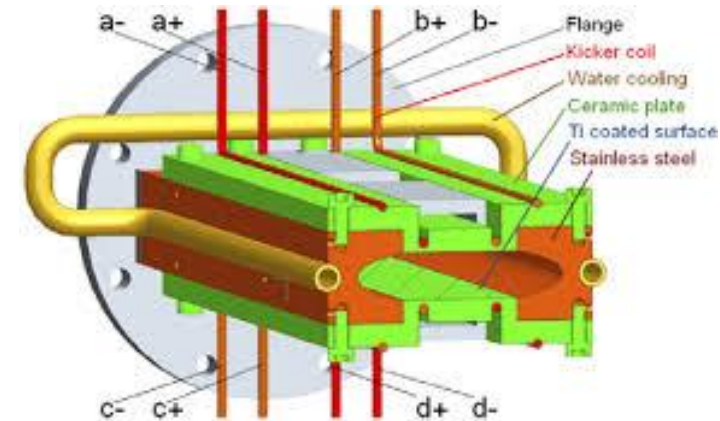
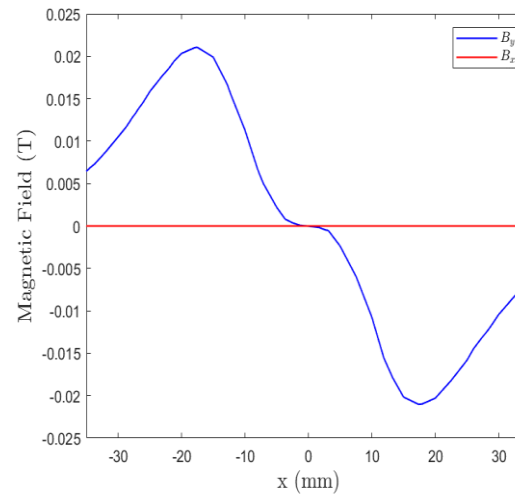
The solution: a nonlinear kicker (NLK)

- What is an NLK?

- A single kicker that produces a nonlinear field to kick the injected beam while leaving the stored beam untouched



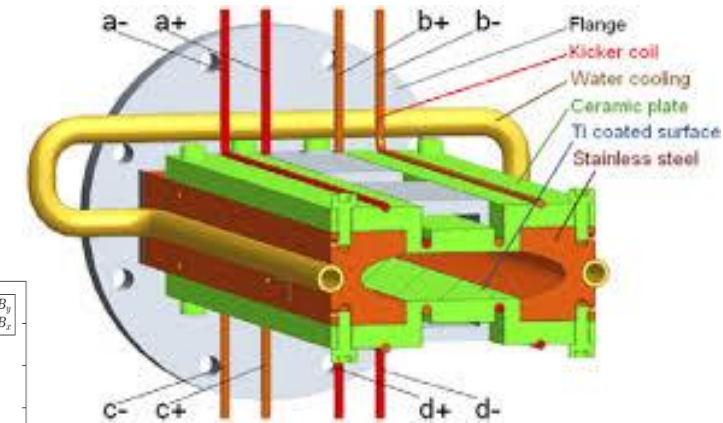
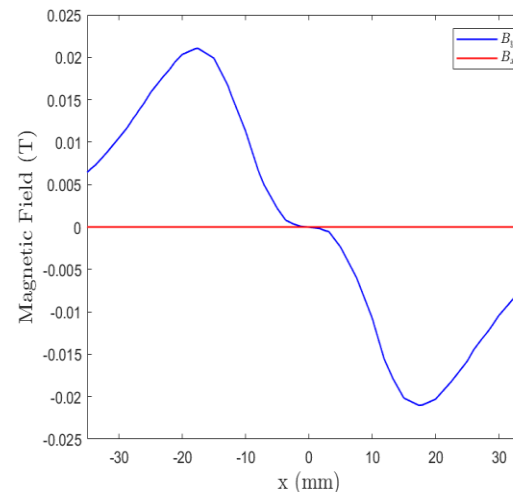
Ref Aiba 2015



Ref Dressler 2011

The solution: a nonlinear kicker (NLK)

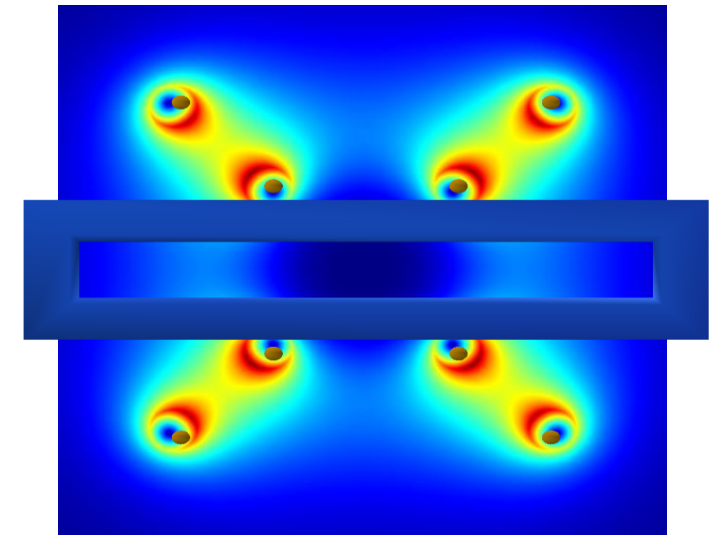
- Solves our BRIGTH problems
 - Stored beam is untouched
 - › Stable jitter-free beam that is transparent in top-up
 - Compact and frees up precious real estate:
 - › NLK = 0.330 m of space
 - › Current 4 kicker configuration: 4 m
 - Transparent to beamlines
 - › More frequent injections
 - › Improve photon intensity stability



Ref Dressler 2011

Preliminary NLK design

- Conductor layout and magnetic field profile without any conductive coating






Challenges other facilities have encountered

- Injection efficiency
 - ~99% theoretically but ~80%-90% when installed
- Ceramic chamber design:
 - Image currents induced on ceramic chamber
 - Stored beam passing through ceramic chamber induces impedance and heat load
 - Charge accumulation across ceramic
 - Needs a sufficient conductive coating to avoid

The complex trade-off in design variables

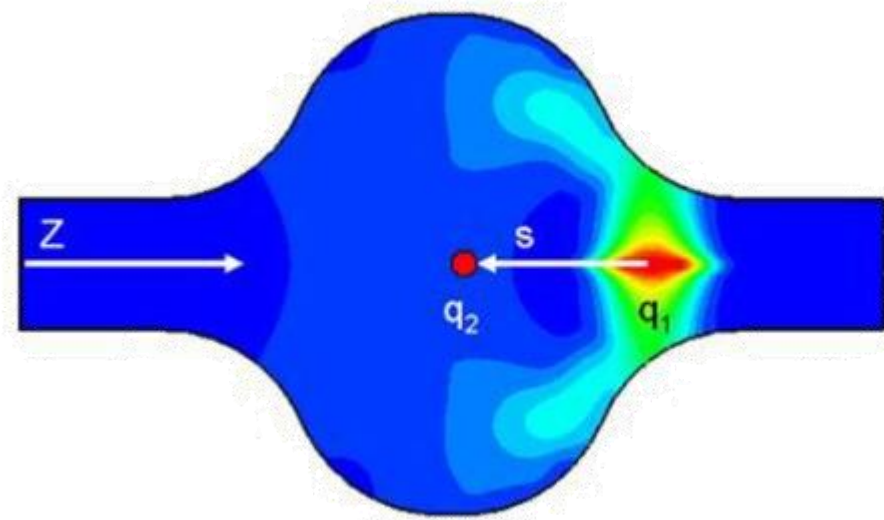
- Interplay of factors will impact the design and performance
- Need to characterize and optimize many features (both physically and logistically)
 - › Conductive coating conductivity (Titanium or Titanium Nitride)
 - › Conductive coating thickness (1 μm to 10 μm)
 - › Aperture of ceramic chamber
 - › Ceramic chamber thickness
 - › Magnetic field response (sufficient kick of beam without gradation)
 - › Copper conductor positions
 - › Length of NLK
- Essentially a multi-objective optimization problem

The impact of conductive coatings

- Conductive coating inside chamber needs to:
 - Decrease beam impedance
 - Decrease charge accumulation across ceramic
 - Guide the image currents
- Coating impacts power deposition, heating, injection efficiency etc.
- Interplay of factors will determine optimal coating. For example a thin film coating provides:
 - Small field distortion 
 - Larger power deposition 
 - Larger thermal load 

Design variables

- Wake impedance relationship with:
 - Stored beam (bunch length, current)
 - Conductive coating
 - › Titanium or Titanium Nitride?
 - › Coating thickness: 1 μm to 10 μm ?
- Magnetic field response
 - Optimal Copper conductor positions to produce sufficient kick of beam without gradation across injected beam or perturbation of stored beam
 - Field Distortion from conductive coating
- Heat load from stored beam image currents
 - Aperture and length of ceramic chamber
 - Power deposition from stored beam



Design variables

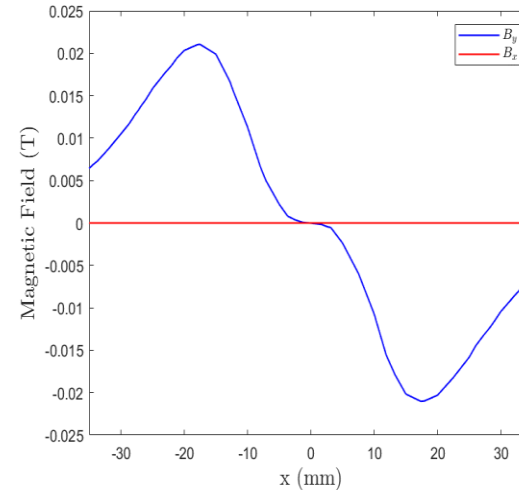
- Wake impedance relationship with:
 - Stored beam (bunch length, current)
 - Conductive coating
 - Titanium or Titanium Nitride?
 - Coating thickness: 1 μm to 10 μm ?

- Field response

- Optimal Copper conductor positions to produce sufficient kick of beam without gradation across injected beam or perturbation of stored beam
- Field Distortion from conductive coating

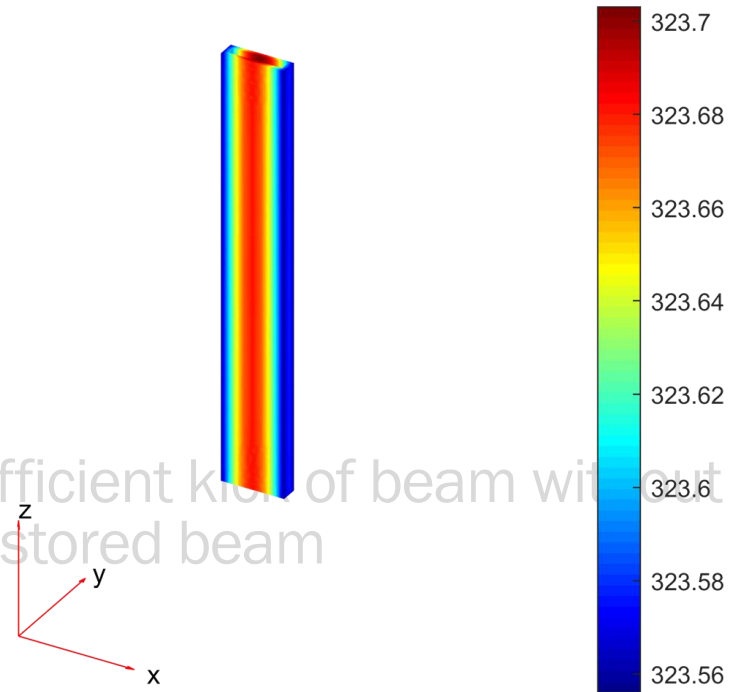
- Heat load from stored beam image currents

- Aperture and length of ceramic chamber
- Power deposition from stored beam



Design variables

- Wake impedance relationship with:
 - Stored beam (bunch length, current)
 - Conductive coating
 - › Titanium or Titanium Nitride?
 - › Coating thickness: 1 μm to 10 μm ?
- Magnetic field response
 - Optimal Copper conductor positions to produce sufficient kick of beam without gradation across injected beam or perturbation of stored beam
 - Field Distortion from conductive coating
- Heat load from stored beam image currents
 - Changes with aperture and length of ceramic chamber
 - Power deposition from stored beam



Results

1. Conductive coating and impedance
2. Field Distortion
3. Power deposition and heat load
4. Injection simulations for nominal design

Results

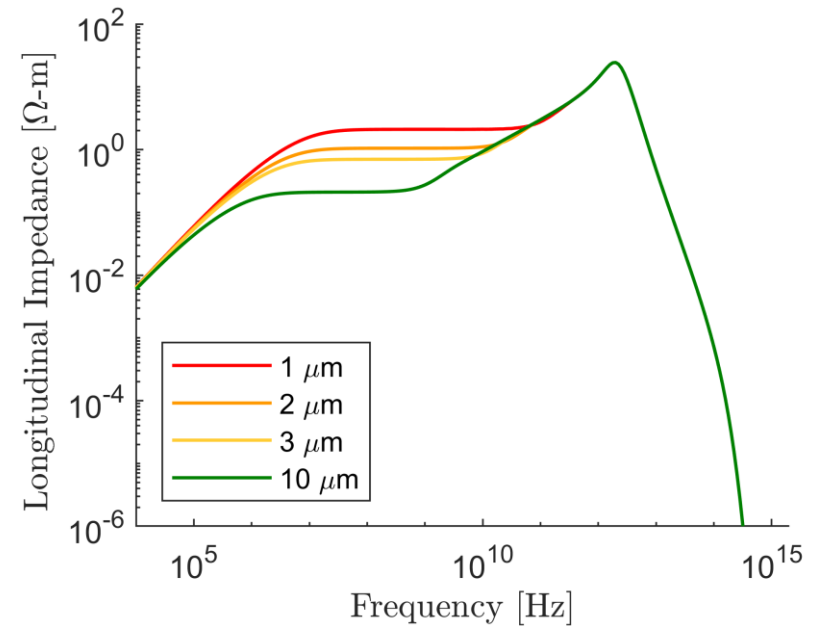
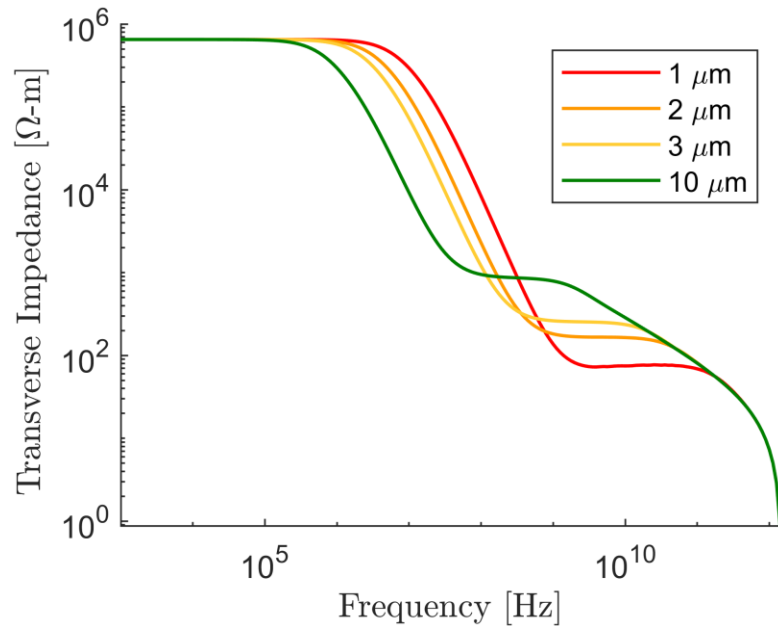
1. Conductive coating and impedance
2. Field Distortion
3. Power deposition and heat load
4. Injection simulations for nominal design

Wake potential and loss for the NLK chamber

- Longitudinal loss factor calculated using CST
- Note, some CST meshing issues
 - Thin film of very small magnitude → millions of cells in CST
- $k_{\parallel} = 0.1 \text{ V/pC}$ for the NLK design with $2 \mu\text{m}$ Ti coating
 - Reasonable value

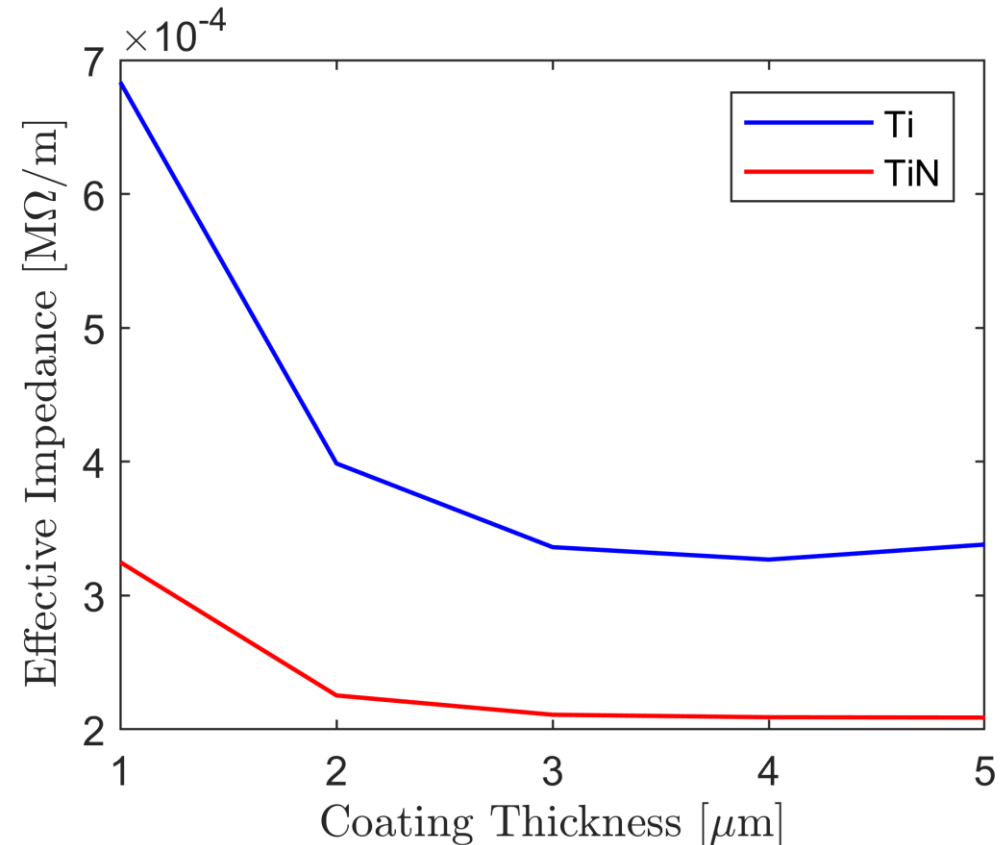
Impedance

- ImpedanceWake2D calculations to determine longitudinal and transverse impedances for various Ti and TiN thicknesses.



Effective Impedance

- For our beam parameters:
 - 3 μm coating will act like bulk Ti due to skin depth.
 - Rules out 4-10 μm Ti or TiN coating as candidates
- Turn to field, power and heat considerations to decide between 1-3 μm Ti/TiN

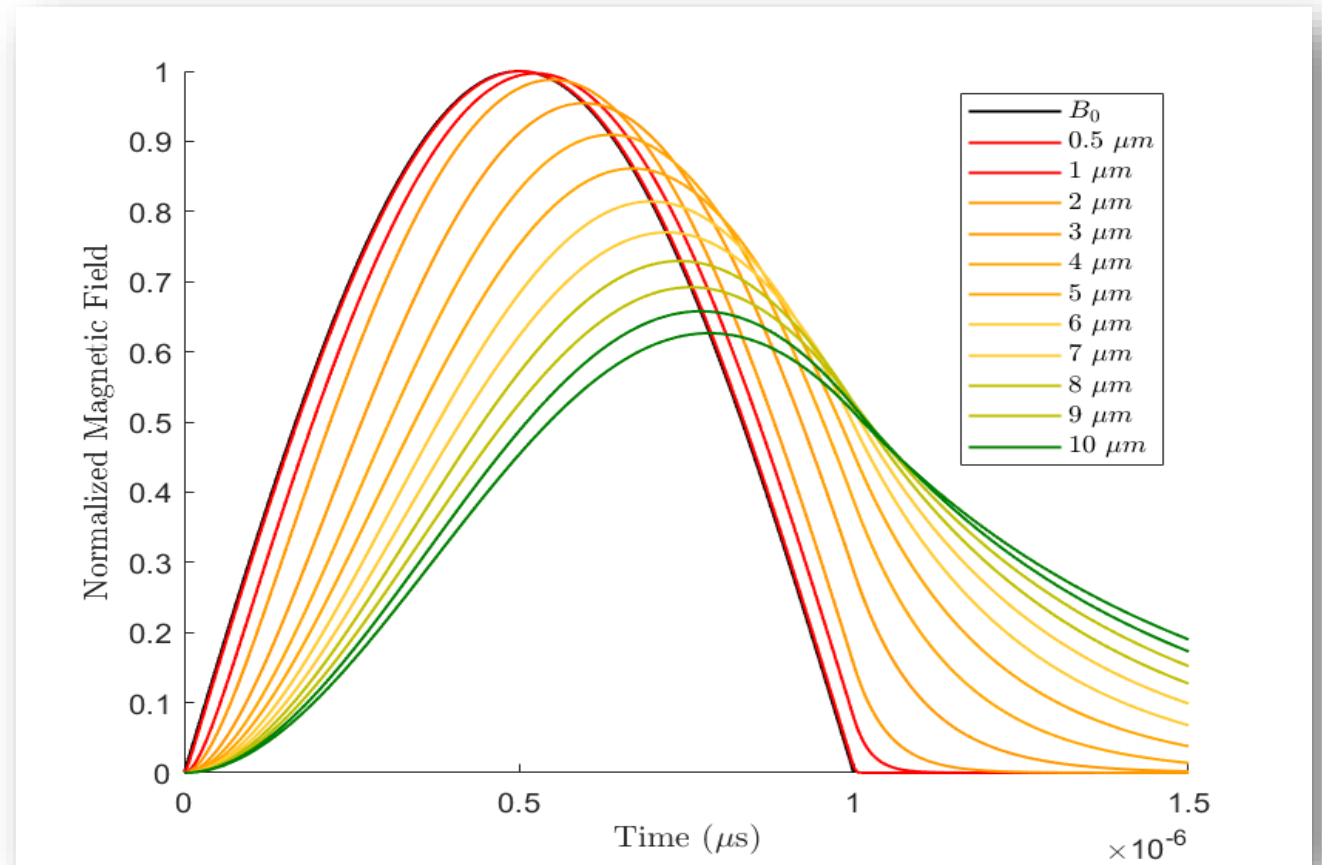


Results

1. Conductive coating and impedance
- 2. Field Distortion**
3. Power deposition and heat load
4. Injection simulations for nominal design

Field Distortion

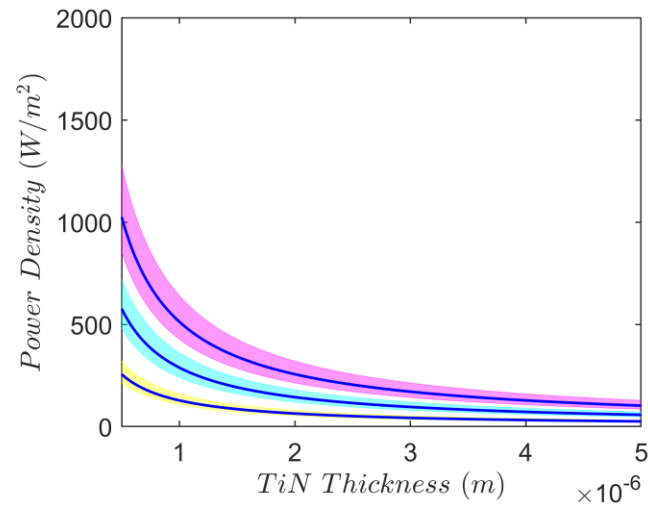
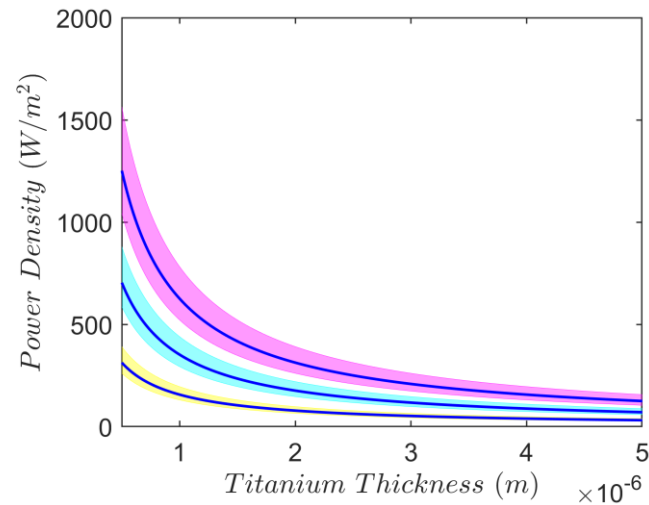
- Assuming:
 - 100 ns bunch train
 - Storage ring (SR) revolution = 720.47 ns
 - Kicker maximum rise time = 620.47 ns
 - Flat top of 100 ns
 - Maximum fall time of 620 ns
- Delay:
 - 1 μm Ti: 45 ns
 - 2 μm Ti: 95 ns
 - 3 μm Ti: 135 ns
- Attenuation:
 - 1 μm Ti: 1.2 %
 - 2 μm Ti: 4.6 %
 - 3 μm Ti: 9.1 %



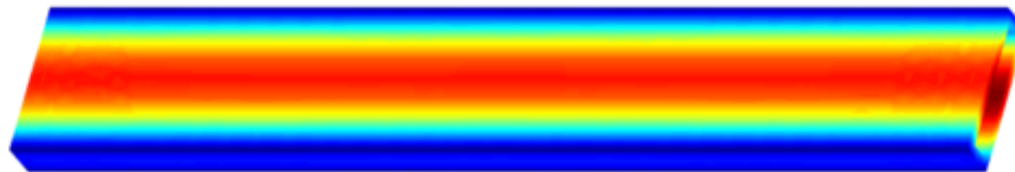
Results

1. Conductive coating and impedance
2. Field Distortion
- 3. Power deposition and heat load**
4. Injection simulations for nominal design

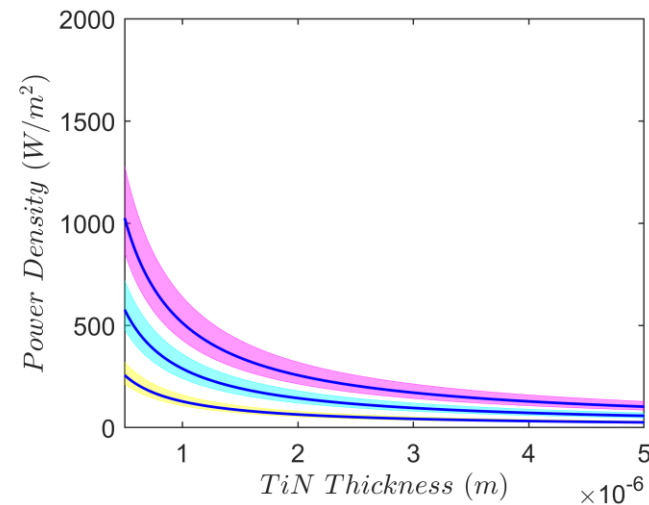
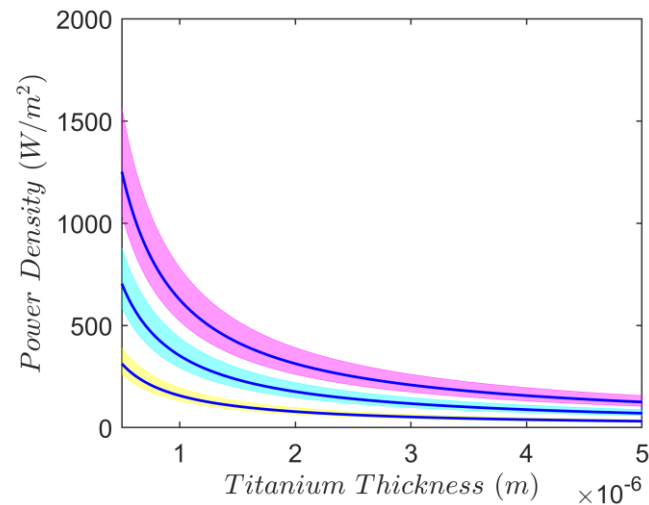
Power Deposition



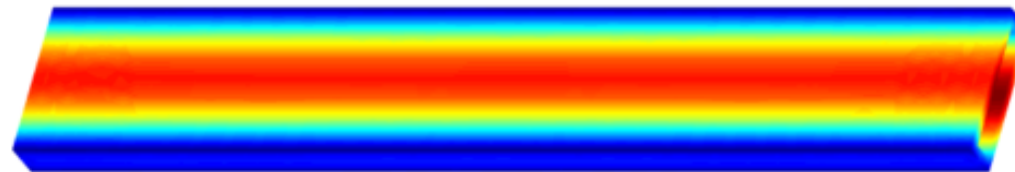
| Thickness (μm) | P_{Ti} (W/m^2) | P_{TiN} (W/m^2) | T_{Ti} ($^{\circ}C$) | T_{TiN} ($^{\circ}C$) |
|-----------------------|----------------------|-----------------------|--------------------------|---------------------------|
| 1 | 625.8 | 512.6 | 150.3 | 127.7 |
| 2 | 312.9 | 256.3 | 87.7 | 76.4 |
| 3 | 208.6 | 170.9 | 66.9 | 59.33 |
| 4 | 156.5 | 128.1 | 56.5 | 50.8 |
| 5 | 124.9 | 102.3 | 50.1 | 45.6 |
| 10 | 62.58 | 51.26 | 37.7 | 35.4 |



Power Deposition

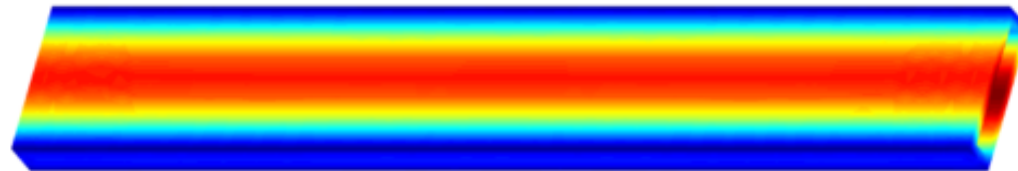


| Thickness (μm) | P_{Ti} (W/m^2) | P_{TiN} (W/m^2) | T_{Ti} ($^{\circ}C$) | T_{TiN} ($^{\circ}C$) |
|-----------------------|----------------------|-----------------------|--------------------------|---------------------------|
| 1 | 625.8 | 512.6 | 150.3 | 127.7 |
| 2 | 312.9 | 256.3 | 87.7 | 76.4 |
| 3 | 208.6 | 170.9 | 66.9 | 59.33 |
| 4 | 156.5 | 128.1 | 56.5 | 50.8 |
| 5 | 124.9 | 102.3 | 50.1 | 45.6 |
| 10 | 62.58 | 51.26 | 37.7 | 35.4 |



Thermal Analysis

- For extreme operating conditions: 400 mA, 260 bunches:
 - 2 μm :
 - › Power: Ti = 312.9 W/m²; TiN = 256.3 W/m²
 - › Max Temp: Ti = 87.7 °C; TiN = 76.4 °C
 - 3 μm :
 - › Power: Ti = 208.6 W/m²; TiN = 170.9 W/m²
 - › Max Temp: Ti = 66.9 °C; TiN = 59.3 °C

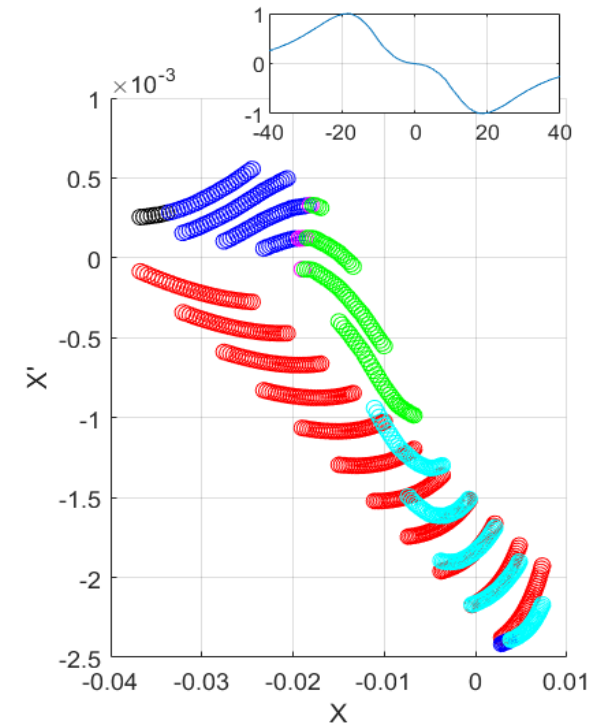
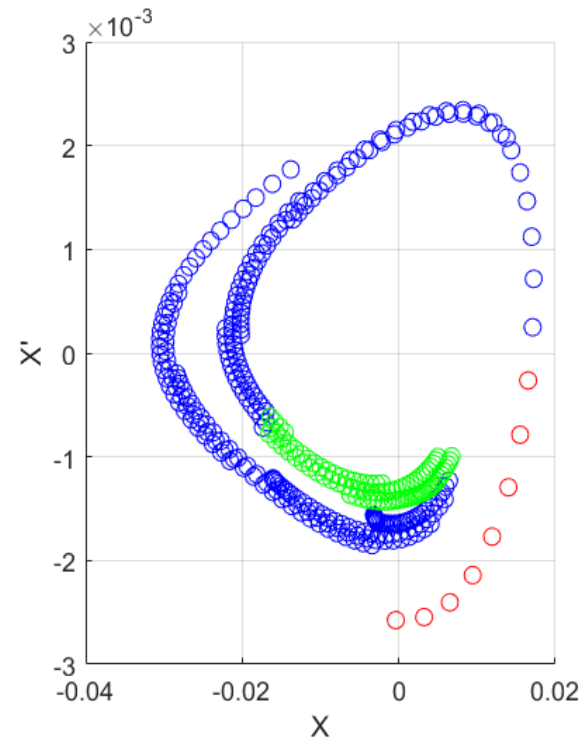
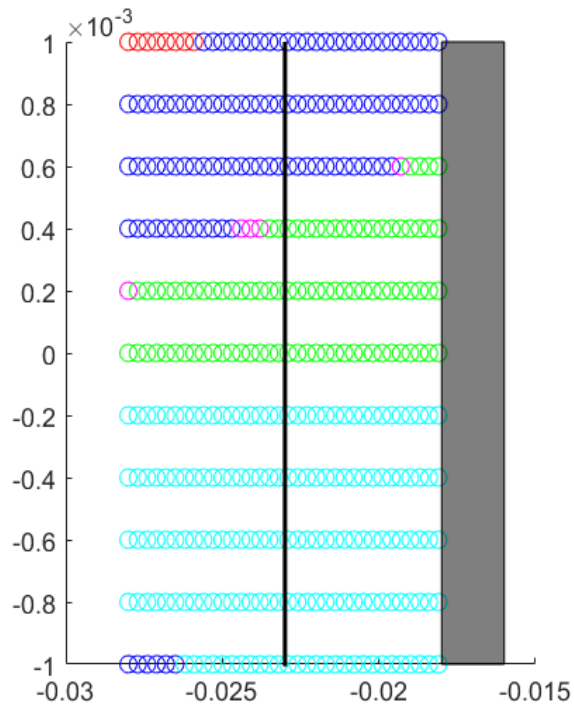


Results

1. Conductive coating and impedance
2. Field Distortion
3. Power deposition and heat load
4. Injection simulations for nominal design

Injection efficiencies and simulations

- Tracking in Sector 5 for 1 mrad kick



Conclusion

- The Australian Synchrotron is looking toward our new BRIGHT beamline requirements (next 5 years) and next gen facility requirements (next 10-15 years)
- A nonlinear injection kicker is optimally positioned to provide the required space, transparency and functionality in our mission to provide cutting edge facilities to our user base
- We have highlighted the multiple (sometimes oppositional) design considerations for the NLK design for the A.S.

Future work

- Refine the CST model
- Check if we have formed any cavities/resonant modes with our design with a IVU installed in same sector downstream
- Next steps: prototype development and commissioning
- Prototype construction late 2019

Acknowledgments

- AS Physics team and operators
- Mr. Olaf Dressler (Helmholtz Berlin)
- Dr. Theo Sinkovis (SAES, Italy)

